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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Masato SUZUKI	02/18/2013
Tetsuro NAKASUGI	02/19/2013

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13780769

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ATTORNEY DOCKET NUMBER:	09814.0181
NAME OF SUBMITTER:	Veronica Bayne
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 2

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PATENT REEL: 029908 FRAME: 0060 OF \$40.00 13/80/69

ACG064151-USA-A

ASSIGNMENT AND DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS I/We, the below named inventor(s), (hereinafter referred to as Assignor(s)), of a claimed invention in an application for United States Letters Patent entitled:

METHOD FOR MANUFACTURING MOLD			
filed herewith or onas attached hereto and/or PCT International Applica	United States Application No ation No; and	(Confirmation No)	
WHEREAS, Kabushiki Kaisha Toshiba a corporation of JAPAN			
whose post office address is1-1, Shibaura 1-6	chome, Minato-ku, Tokyo, JAPAN		
(hereinafter referred to as Assignee), is desirous application for United States Letters Patent on the			
NOW THEREFORE, be it known that, for good a acknowledged, I/WE, as Assignor(s), have sold, and set over unto the Assignee, its lawful success invention and this application, and all divisions, a which may be granted thereon, and all reissues to States Patent and Trademark Office to issue all I in accordance with the terms of this Assignment;	assigned, transferred, and set over sors and assigns, my/our entire ri and continuations thereof, and all L thereof; and I/WE hereby authorize Letters Patent for this invention to	er, and do hereby sell, assign, transfer, ight, title, and interest in and to this Letters Patent of the United States e and request the Director of the United	
AND, I/WE HEREBY further covenant and agree its successors and assigns, any facts known to n lawful papers when called upon to do so, execute title to this invention in said Assignee, its success applications, make all rightful oaths and generally obtain and enforce proper patent protection for the incident to the execution of such papers shall be	ne/us respecting this invention and e and deliver all papers that may b sors and assigns, execute all divis y do everything possible to aid Ass nis invention in the United States, i	d testify in any legal proceeding, sign all be necessary or desirable to perfect the sional, continuation, and reissue signee, its successors and assigns, to it being understood that any expense	
AND, I/WE HEREBY authorize and request that parentheses (Application Nosaid application when known.	the attorneys having Power of Atto , filed	orney in this application, insert here in the filing date and application number of	
As a named inventor below, I hereby declare that (2) the above-identified application was made or as stated below next to my name; and (4) I believe invention in the application. I hereby acknowledge punishable by fine or imprisonment of not more to States Code.	authorized to be made by me; (3) ve I am an original inventor or an o ge that any willful false statements	my residence and mailing address are original joint inventor of a claimed made in this declaration are	
As a below named inventor, I have reviewed and aware of the duty to disclose to the USPTO all in 37C.F.R. § 1.56.			

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SOLE/JOINT INVENTION (U.S. Rights Only) Attorney Docket No.

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Authorization To Permit Access To Application by Participating Offices:

If checked, the undersigned hereby grants the USPTO authority to provide the European Patent Office (EPO), the Japan Patent Office (JPO), the Korean Intellectual Property Office (KIPO), the World Intellectual Property Office (WIPO), and any other intellectual property offices in which a foreign application claiming priority to the above-identified patent application is filed access to the above-identified patent application. See 37 CFR 1.14(c) and (h). This box should not be checked if the Applicant does not wish the EPO, JPO, KIPO, WIPO, or other intellectual property office in which a foreign application claiming priority to the above-identified application is filed to have access to the above identified patent application.

In accordance with 37 CFR 1.14(h)(3), access will be provided to a copy of the above-identified patent application with respect to: 1) the above-identified patent application-as-filed; 2) any foreign application to which the above-identified patent application claims priority under 35 U.S.C. 119(a)-(d) if a copy of the foreign application that satisfies the certified copy requirement of 37 CFR 1.55 has been filed in the above-identified patent application; and 3) any U.S. application-as-filed from which benefit is sought in the above-identified patent application.

In accordance with 37 CFR 1.14(c), access may be provided to information concerning the date of filing the Authorization to Permit Access to Application by Participating Offices.

1. FULL NAME OF SOLE OR FIRST ASSIGNOR	ASSIGNOR'S SIGNATURE	DATE
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2. FULL NAME OF SECOND ASSIGNOR	ASSIGNOR'S SIGNATURE	DATE
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